





SURFACE MOUNT SCHOTTKY BARRIER DIODE

Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (mA)	V _{F(MAX)} (mV)	I _{R(MAX)} (μA)
60	500	630	40

Applications

- DC DC Converters
- Mobile Telecomms
- PCMIA

Features and Benefits

- High Current Capability (I_O = 500mA)
- Low V_F
- Totally Lead-Free & Fully RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SOT23
- Case Material: Molded Plastic, "Green" Molding Compound.
 UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Matte Tin Finish Annealed over Alloy 42 Leadframe (Lead Free Plating). Solderable per MIL-STD-202, Method 208 (3)
- Weight: 0.0089 grams (Approximate)



Top View



NC 2

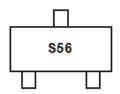
Ordering Information (Note 5)

Device	Packaging	Shipping
ZHCS506QTA	SOT23	3000/Tape & Reel

Notes:

- 1. No purposely added lead. Fully EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant.
- 2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.
- 3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.
- 4. Automotive products are AEC-Q101 qualified and are PPAP capable. Refer to http://www.diodes.com/product_compliance_definitions.html.
- 5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information



S56 = Product Type Marking Code



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Characteristic		Symbol	Value	Unit
Continuous Reverse Voltage		V _{RRM}	60	V
Continuous Forward Current		lo	500	mA
Forward Voltage @I _F =500mA		V _F	630	mV
Average Peak Forward Current; D.C. = 50%		I _{FAV}	1000	mA
Non Repetitive Forward Current	t ≤ 100µs	l	5.5	Α
Non Repetitive Forward Current	$t \le 10 ms$	IFSM	2.5	Α

Thermal Characteristics

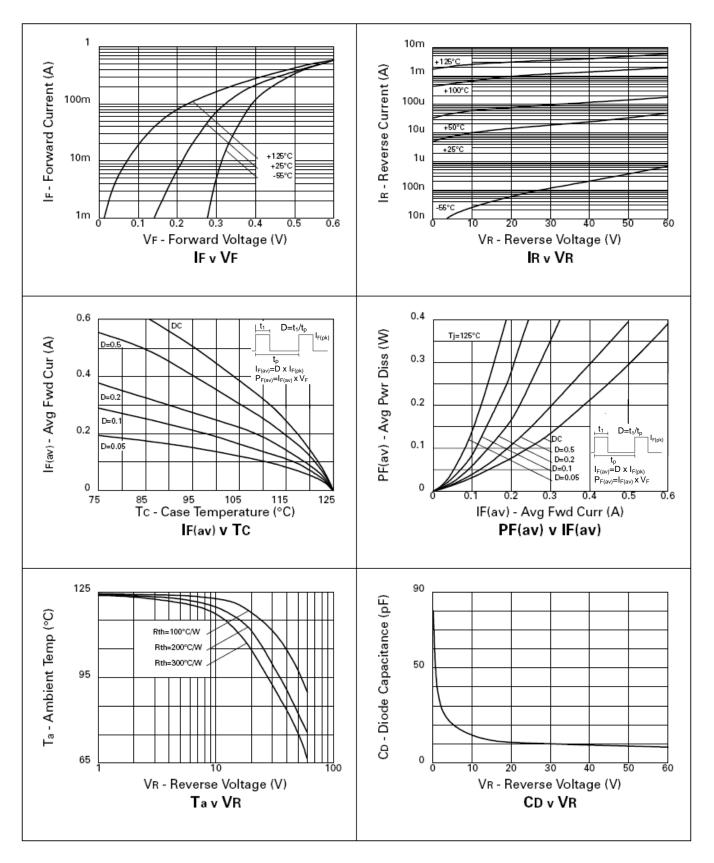
Characteristic	Symbol	Value	Unit
Power Dissipation, T _A = +25°C	P_{D}	330	mW
Junction Temperature	TJ	+125	°C
Storage Temperature Range	T _{STG}	-55 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

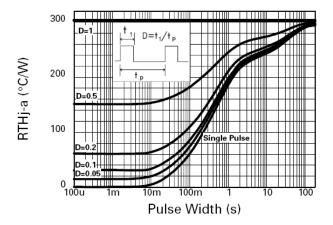
Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage	$V_{(BR)R}$	60	80	_	V	$I_R = 200\mu A$
			275	310	mV	I _F = 50mA
			320	360		I _F = 100mA
	VF	_	415	470		I _F = 250mA
Famurad Voltage (Note 6)		_	550	630		I _F = 500mA
Forward Voltage (Note 6)		_	680	800	IIIV	I _F = 750mA
		_	820	960		I _F = 1A
		_	1120	1350		I _F = 1.5A
		_	565	_		I _F = 500mA, T _A = +100°C
Reverse Current	I _R	_	20	40	μA	V _R = 45V
Diode Capacitance	C _D	_	20	_	pF	f = 1MHz, V _R = 25V
Reverse Recovery Time	t _{RR}	_	10	_	ns	Switched from $I_F = 500$ mA to $I_R = 500$ mA Measured @ $I_R = 50$ mA

Note: 6. Measured under pulsed conditions. Pulse width = 300μ S. Duty cycle 2%.





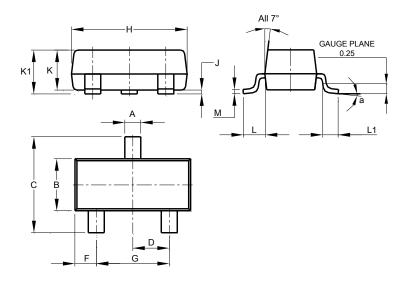




Package Outline Dimensions

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



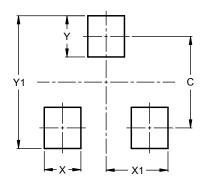
SOT23					
Dim	Min	Max	Тур		
Α	0.37	0.51	0.40		
В	1.20	1.40	1.30		
С	2.30	2.50	2.40		
D	0.89	1.03	0.915		
F	0.45	0.60	0.535		
G	1.78	2.05	1.83		
Н	2.80	3.00	2.90		
J	0.013	0.10	0.05		
K	0.890	1.00	0.975		
K 1	0.903	1.10	1.025		
L	0.45	0.61	0.55		
L1	0.25	0.55	0.40		
M	0.085	0.150	0.110		
а	0°	8°			
All Dimensions in mm					



Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.

SOT23



Dimensions	Value (in mm)		
С	2.0		
Х	0.8		
X1	1.35		
Y	0.9		
Y1	2.9		

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